

Title (en)

COMPOSITIONS AND METHODS FOR SEPARATION OF MOIETIES ON CHIPS

Title (de)

ZUSAMMENSETZUNGEN UND VERFAHREN ZUR TRENNUNG VON WIRKSAMEN ANTEILEN AUF CHIPS

Title (fr)

COMPOSITIONS ET PROCEDES DE SEPARATION DE FRACTIONS SUR DES PUCES

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Abstract (en)

[origin: WO0231506A1] The present invention recognizes that separation of components of a sample facilitate, and are often necessary for, sample analysis. Dielectrophoretic separation provides an efficient, reliable, nondisruptive, and automatable method for the separation of moieties in a sample based on their dielectric properties. The present invention provides compositions and methods for enhancing the dielectrophoretic separation of one or more moieties in a sample.

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